

SDLS204

SN54S135, SN74S135 QUADRUPLE EXCLUSIVE-OR/NOR GATES

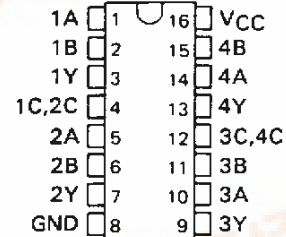
DECEMBER 1972—REVISED MARCH 1988

- Fully Compatible with Most TTL and TTL MSI Circuits
- Fully Schottky Clamping Reduces Delay Times . . . 8 ns Typical
- Can Operate as Exclusive-OR Gate (C Input Low) or as Exclusive-NOR Gate (C Input High)

SN54S135 . . . J OR W PACKAGE

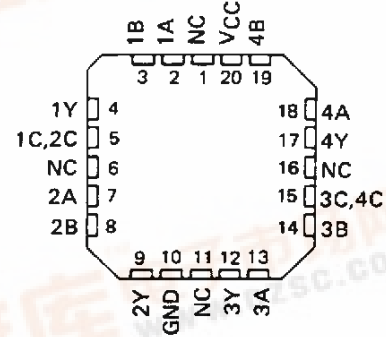
SN74S135 . . . D OR N PACKAGE

(TOP VIEW)



SN54S135 . . . FK PACKAGE

(TOP VIEW)



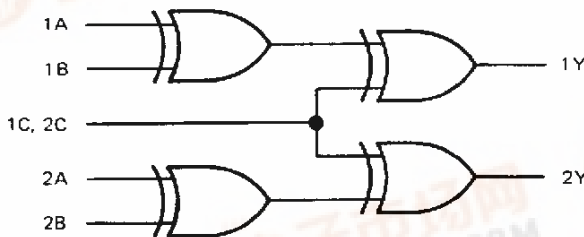
NC - No internal connection

FUNCTION TABLE

INPUTS			OUTPUT Y
A	B	C	
L	L	L	L
L	H	L	H
H	L	L	H
H	H	L	L
L	L	H	H
L	H	H	L
H	L	H	L
H	H	H	H

H = high level, L = low level

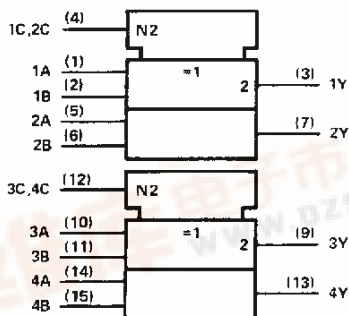
logic diagram (one half)



positive logic

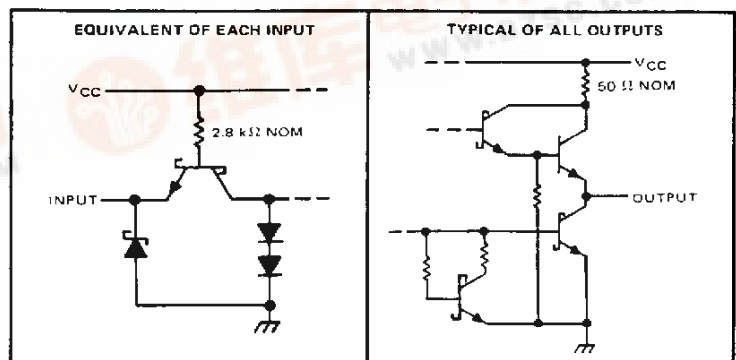
$$Y = A \oplus B \oplus C = \overline{A}\overline{B}C + \overline{A}B\overline{C} + A\overline{B}\overline{C} + ABC$$

logic symbol†



†This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12. Pin numbers are for D, J, N, and W packages.

schematics of inputs and outputs



Resistor values shown are nominal.

SN54S135, SN74S135 QUADRUPLE EXCLUSIVE-OR/NOR GATES

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1)	7 V
Input voltage	5.5 V
Operating free-air temperature range: SN54S135	-55°C to 125°C
SN74S135	0°C to 70°C
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54S135			SN74S135			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}	4.5	5	5.5	4.75	5	5.25	V
High-level output current, I_{OH}			-1			-1	mA
Low-level output current, I_{OL}			20			20	mA
Operating free-air temperature, T_A	-65		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V_{IH} High-level input voltage		2			V
V_{IL} Low-level input voltage				0.8	V
V_{IK} Input clamp voltage	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$			-1.2	V
V_{OH} High-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OH} = -1 \text{ mA}$	2.5	3.4		V
V_{OL} Low-level output voltage	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V},$ $V_{IL} = 0.8 \text{ V}, I_{OL} = 20 \text{ mA}$			0.5	V
I_I Input current at maximum input voltage	$V_{CC} = \text{MAX}, V_I = 5.5 \text{ V}$			1	mA
I_{IH} High-level input current	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$			50	µA
I_{IL} Low-level input current	$V_{CC} = \text{MAX}, V_I = 0.5 \text{ V}$			-2	mA
I_{OS} Short-circuit output current§	$V_{CC} = \text{MAX}$	-40		-100	mA
I_{CC} Supply current	$V_{CC} = \text{MAX}, \text{ See Note 2}$		65	99	mA

†For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

‡All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

NOTE 2: I_{CC} is measured with the inputs grounded and the outputs open.

switching characteristics, $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$

PARAMETER	FROM (INPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_{PLH}	A or B	B or A = L, C = L	8.5	13	15	ns
t_{PHL}						
t_{PLH}	A or B	B or A = H, C = L	8	12	13.5	ns
t_{PHL}						
t_{PLH}	A or B	B or A = L, C = H	10	15	16	ns
t_{PHL}						
t_{PLH}	A or B	B or A = H, C = H	8.5	12	13	ns
t_{PHL}						
t_{PLH}	C	A = B	8	12	14.5	ns
t_{PHL}						
t_{PLH}	C	A ≠ B	7.5	11.5	12	ns
t_{PHL}						

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

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